LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V, LM224K, LM224KA, LM324K, LM324KA, LM2902K, LM2902KV, LM2902KAV QUADRUPLE OPERATIONAL AMPLIFIERS

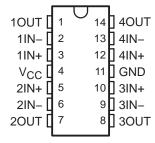
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- 2-kV ESD Protection for:
 - LM224K, LM224KA
 - LM324K, LM324KA
 - LM2902K, LM2902KV, LM2902KAV
- Wide Supply Ranges
 - Single Supply . . . 3 V to 32 V (26 V for LM2902)
 - Dual Supplies . . . ±1.5 V to ±16 V (±13 V for LM2902)
- Low Supply-Current Drain Independent of Supply Voltage . . . 0.8 mA Typ
- Common-Mode Input Voltage Range Includes Ground, Allowing Direct Sensing Near Ground
- Low Input Bias and Offset Parameters
 - Input Offset Voltage . . . 3 mV Typ
 A Versions . . . 2 mV Typ
 - Input Offset Current . . . 2 nA Typ
 - Input Bias Current . . . 20 nA Typ
 A Versions . . . 15 nA Typ
- Differential Input Voltage Range Equal to Maximum-Rated Supply Voltage . . . 32 V (26 V for LM2902)
- Open-Loop Differential Voltage Amplification . . . 100 V/mV Typ
- Internal Frequency Compensation

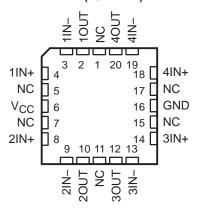
description/ordering information

These devices consist of four independent high-gain frequency-compensated operational amplifiers that are designed specifically to operate from a single supply over a wide range of voltages. Operation from split supplies also is possible if the difference between the two supplies is 3 V to 32 V (3 V to 26 V for the LM2902), and V_{CC} is at least 1.5 V more positive than the input common-mode voltage. The low supply-current drain is independent of the magnitude of the supply voltage.

LM124 . . . D, J, OR W PACKAGE
LM124A . . . J OR W PACKAGE
LM224, LM224A, LM224K, LM224KA . . . D OR N PACKAGE
LM324, LM324K . . . D, N, NS, OR PW PACKAGE
LM324A . . . D, DB, N, NS, OR PW PACKAGE
LM324KA . . . D, N, NS, OR PW PACKAGE
LM2902 . . . D, N, NS, OR PW PACKAGE
LM2902K . . . D, DB, N, NS, OR PW PACKAGE
LM2902KV, LM2902KAV . . . D OR PW PACKAGE
(TOP VIEW)



LM124, LM124A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

Applications include transducer amplifiers, dc amplification blocks, and all the conventional operational-amplifier circuits that now can be more easily implemented in single-supply-voltage systems. For example, the LM124 can be operated directly from the standard 5-V supply that is used in digital systems and provides the required interface electronics, without requiring additional ± 15 -V supplies.

LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V, LM224K, LM224KA, LM324K, LM324KA, LM2902KV, LM2902KAV QUADRUPLE OPERATIONAL AMPLIFIERS

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description/ordering information (continued)

ORDERING INFORMATION

TA	V _{IO} max AT 25°C	MAX TESTED VCC	PACK	AGET	ORDERABLE PART NUMBER	TOP-SIDE MARKING				
					LM324N	LM324N				
			PDIP (N)	Tube of 25	LM324KN	LM324KN				
				Tube of 50	LM324D					
				Reel of 2500	LM324DR	LM324				
			SOIC (D)	Tube of 50	LM324KD	11100417				
				Reel of 2500	LM324KDR	LM324K				
	7 mV	30 V		Reel of 2000	LM324NSR	LM324				
			SOP (NS)	Tube of 50	LM324KNS					
				Reel of 2000	LM324KNSR	LM324K				
				Tube of 90	LM324PW					
				Reel of 2000	LM324PWR	L324				
			TSSOP (PW)	Tube of 90	LM324KPW	1.00414				
				Reel of 2000	LM324KPWR	L324K				
0°C to 70°C			2212 (0.0)	Tube of 25	LM324AN	LM324AN				
			PDIP (N)	Tube of 25	LM324KAN	LM324KAN				
				Tube of 50	LM324AD					
3 mV			SOIC (D)	Reel of 2500	LM324ADR	LM324A				
				Tube of 50	LM324KAD					
				Reel of 2500	LM324KADR	LM324KA				
	201/		Reel of 2000	LM324ANSR	LM324A					
	3 mV	30 V	SOP (NS)	Tube of 50	LM324KANS					
					(10)	(10)	(1.5)	(1.15)	Reel of 2000	LM324KANSR
			SSOP (DB)	Reel of 2000	LM324ADBR	LM324A				
				Tube of 90	LM324APW					
				Reel of 2000	LM324APWR	L324A				
			TSSOP (PW)	Tube of 90	LM324KAPW					
				Reel of 2000	LM324KAPWR	L324KA				
				1	LM224N	LM224N				
			PDIP (N)	Tube of 25	LM224KN	LM224KN				
				Tube of 50	LM224D	1				
	5 mV	30 V		Reel of 2500	LM224DR	LM224				
			SOIC (D)	Tube of 50	LM224KD	1				
25°C to 85°C				Reel of 2500	LM224KDR	LM224K				
-25°C to 85°C				Tube of 25	LM224AN	LM224AN				
			PDIP (N)	Tube of 25	LM224KAN	LM224KAN				
				Tube of 50	LM224AD					
	3 mV	30 V				F	/ Re	Reel of 2500	LM224ADR	LM224A
			SOIC (D)	Tube of 50	LM224KAD					
				Reel of 2500	LM224KADR	LM224KA				

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



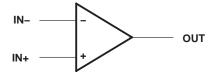
LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V, LM224K, LM224KA, LM324K, LM324KA, LM2902K, LM2902KV, LM2902KAV QUADRUPLE OPERATIONAL AMPLIFIERS SLOS066S - SEPTEMBER 1975 - REVISED JULY 2008

ORDERING INFORMATION (CONTINUED)

ТД	V _{IO} max AT 25°C	MAX TESTED VCC	PACKA	.GE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
			DDID (AI)	Tube of 25	LM2902N	LM2902N
			PDIP (N)	Tube of 25	LM2902KN	LM2902KN
				Tube of 50	LM2902D	1.140000
			0010 (D)	Reel of 2500	LM2902DR	LM2902
			SOIC (D)	Tube of 50	LM2902KD	LAMOOOOK
				Reel of 2500	LM2902KDR	LM2902K
				Reel of 2000	LM2902NSR	LM2902
		26 V	SOP (NS)	Tube of 50	LM2902KNS	LMOOON
	7 mV			Reel of 2000	LM2902KNSR	LM2902K
-40°C to 125°C			0000 (00)	Tube of 80	LM2902KDB	1.000014
			SSOP (DB)	Reel of 2000	LM2902KDBR	L2902K
				Tube of 90	LM2902PW	1,000
			T0000 (D)40	Reel of 2000	LM2902PWR	L2902
			TSSOP (PW)	Tube of 90	LM2902KPW	1.000016
				Reel of 2000	LM2902KPWR	L2902K
		32 V	SOIC (D)	Reel of 2500	LM2902KVQDR	L2902KV
		32 V	TSSOP (PW)	Reel of 2000	LM2902KVQPWR	L2902KV
	0 1/	00.17	SOIC (D)	Reel of 2500	LM2902KAVQDR	L2902KA
	2 mV	32 V	TSSOP (PW)	Reel of 2000	LM2902KAVQPWR	L2902KA
			CDIP (J)	Tube of 25	LM124J	LM124J
			CFP (W)	Tube of 25	LM124W	LM124W
	5 mV	30 V	LCCC (FK)	Tube of 55	LM124FK	LM124FK
5500 / 40500				Tube of 50	LM124D	
−55°C to 125°C			SOIC (D)	Reel of 2500	LM124DR	LM124
			CDIP (J)	Tube of 25	LM124AJ	LM124AJ
	2 mV	30 V	CFP (W)	Tube of 25	LM124AW	LM124AW
			LCCC (FK)	Tube of 55	LM124AFK	LM124AFK

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

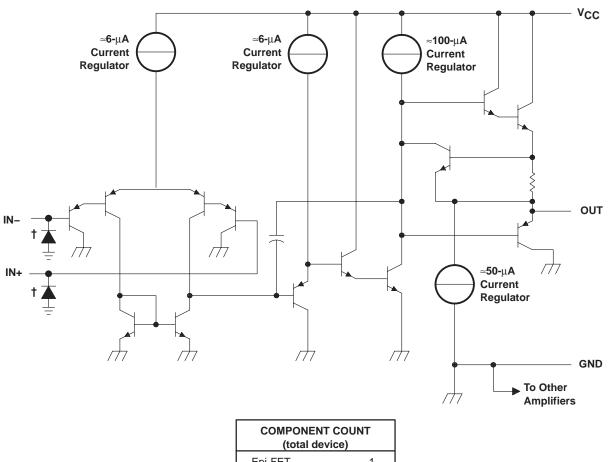
symbol (each amplifier)



LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V, LM224K, LM224KA, LM324K, LM324KA, LM2902KV, LM2902KAV QUADRUPLE OPERATIONAL AMPLIFIERS

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schematic (each amplifier)



COMPONENT (total devi							
Epi-FET	1						
Transistors 95							
Diodes	4						
Resistors	11						
Capacitors	4						

[†]ESD protection cells - available on LM324K and LM324KA only

LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V, LM224K, LM224KA, LM324KA, LM324KA, LM2902K, LM2902KV, LM2902KAV QUADRUPLE OPERATIONAL AMPLIFIERS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

		LM2902	ALL OTHER DEVICES	UNIT
Supply voltage, V _{CC} (see Note 1)		±13 or 26	±16 or 32	V
Differential input voltage, V _{ID} (see Note 2)		±26	±32	V
Input voltage, V _I (either input)		-0.3 to 26	-0.3 to 32	V
Duration of output short circuit (one amplifier) to ground at (or below) $T_{A} = V_{CC} \le 15 \text{ V}$ (see Note 3)	Λ = 25°C,	Unlimited	Unlimited	
	D package	86	86	
	DB package	96	96	
Package thermal impedance, θ _{JA} (see Notes 4 and 5)	N package	80	80	°C/W
	NS package	76	76	
	PW package	113	113	
	FK package		5.61	
Package thermal impedance, θ_{JC} (see Notes 6 and 7)	J package		15.05	°C/W
	W package		14.65	
Operating virtual junction temperature, TJ		150	150	°C
Case temperature for 60 seconds	FK package		260	°C
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds	J or W package	300	300	°C
Storage temperature range, T _{Stg}		-65 to 150	-65 to 150	°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values (except differential voltages and VCC specified for the measurement of IOS) are with respect to the network GND.

- 2. Differential voltages are at IN+, with respect to IN-.
- 3. Short circuits from outputs to V_{CC} can cause excessive heating and eventual destruction.
- 4. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
- 5. The package thermal impedance is calculated in accordance with JESD 51-7.
- 6. Maximum power dissipation is a function of $T_J(max)$, θ_{JC} , and T_C . The maximum allowable power dissipation at any allowable case temperature is $P_D = (T_J(max) T_C)/\theta_{JC}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
- 7. The package thermal impedance is calculated in accordance with MIL-STD-883.

ESD protection

	TEST CONDITIONS	TYP	UNIT
Human-Body Model	LM224K, LM224KA, LM324K, LM324KA, LM2902K, LM2902KV, LM2902KAV	±2	kV



LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V, LM224K, LM224KA, LM324K, LM324KA, LM2902KV, LM2902KAV QUADRUPLE OPERATIONAL AMPLIFIERS

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electrical characteristics at specified free-air temperature, $V_{CC} = 5 \text{ V}$ (unless otherwise noted)

P/	ARAMETER	TEST CON	DITIONS†	T _A ‡		.M124 .M224			_M324 M324K		UNIT
					MIN	TYP§	MAX	MIN	TYP§	MAX	_
VIO	Input offset voltage	$V_{CC} = 5 \text{ V to MA}$	λX,	25°C		3	5		3	7	mV
۷IO	input onset voltage	V _{IC} = V _{ICR} min,	$V_0 = 1.4 \text{ V}$	Full range			7			9	IIIV
l _{IO}	Input offset current	V _O = 1.4 V		25°C		2	30		2	50	nA
10	input onset current	VO = 1.4 V		Full range			100			150	117.
I _{IB}	Input bias current	V _O = 1.4 V		25°C		-20	-150		-20	-250	nA
10	,	Ŭ		Full range			-300			-500	
V _{ICR}	Common-mode	V _{CC} = 5 V to MA	ΛX	25°C	0 to V _{CC} - 1.5			0 to V _{CC} – 1.5			V
TICK	input voltage range	VCC = 0 V 10 1111		Full range	0 to V _{CC} – 2			0 to V _{CC} – 2			•
		$R_L = 2 k\Omega$		25°C	V _{CC} – 1.5			V _{CC} – 1.5			
Voн	High-level	$R_L = 10 \text{ k}\Omega$		25°C							V
VOH	output voltage	$V_{CC} = MAX$ $R_L = 2 k\Omega$		Full range	26			26			V
		VCC = 1017 CK	$R_L \ge 10 \text{ k}\Omega$	Full range	27	28		27	28		
VOL	Low-level output voltage	$R_L \le 10 \text{ k}\Omega$		Full range		5	20		5	20	mV
	Large-signal	Vcc = 15 V Vc	Voc = 15 V Vo = 1 V to 11 V		50	100		25	100		
AVD	differential voltage amplification	$R_L \ge 2 k\Omega$	V_{CC} = 15 V, V_{O} = 1 V to 11 V, $R_{L} \ge 2 \ k\Omega$		25			15			V/mV
CMRR	Common-mode rejection ratio	$V_{IC} = V_{ICR}min$		25°C	70	80		65	80		dB
k _{SVR}	Supply-voltage rejection ratio (∆V _{CC} /∆V _{IO})			25°C	65	100		65	100		dB
V _{O1} /V _{O2}	Crosstalk attenuation	f = 1 kHz to 20 k	Hz	25°C		120			120		dB
		V _{CC} = 15 V,		25°C	-20	-30	-60	-20	-30	-60	
		$V_{ID} = 1 V$, $V_{O} = 0$	Source	Full range	-10			-10			
IO	Output current	V _{CC} = 15 V,		25°C	10	20		10	20		mA
	·	$V_{ID} = -1 \text{ V},$ $V_{O} = 15 \text{ V}$	Sink	Full range	5			5			
		V _{ID} = -1 V,	V _O = 200 mV	25°C	12	30		12	30		μА
I _{OS}	Short-circuit output current	V _{CC} at 5 V, GND at –5 V	V _O = 0,	25°C		±40	±60		±40	±60	mA
	4	V _O = 2.5 V,	No load	Full range		0.7	1.2		0.7	1.2	
ICC	Supply current (four amplifiers)	V _{CC} = MAX, V _O = 0.5 V _{CC} ,	No load	Full range		1.4	3		1.4	3	mA

[†] All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified. MAX V_{CC} for testing purposes is 26 V for LM2902 and 30 V for the others.



[‡] Full range is -55°C to 125°C for LM124, -25°C to 85°C for LM224, and 0°C to 70°C for LM324.

[§] All typical values are at $T_A = 25$ °C.

LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V, LM224K, LM224KA, LM324KA, LM324KA, LM2902KV, LM2902KAV QUADRUPLE OPERATIONAL AMPLIFIERS

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electrical characteristics at specified free-air temperature, $V_{CC} = 5 \text{ V}$ (unless otherwise noted)

	ADAMETED		t	_ +	LN	/12902		LN	/12902V		
P	ARAMETER	TEST CON	DITIONS	T _A ‡	MIN	TYP§	MAX	MIN	TYP§	MAX	UNIT
			Non-A-suffix	25°C		3	7		3	7	
V	Innut offeet veltere	$V_{CC} = 5 \text{ V to}$ MAX,	devices	Full range			10			10	mV
VIO	Input offset voltage	$V_{IC} = V_{ICR}$ min, $V_{O} = 1.4 \text{ V}$	A-suffix	25°C					1	2	mv
		VO = 1.4 V	devices	Full range						4	
ΔV _{ΙΟ} /ΔΤ	Input offset voltage temperature drift	$R_S = 0 \Omega$		Full range					7		μV/°C
1	Input offset current	V- 4.4.V		25°C		2	50		2	50	nA
lio	input onset current	V _O = 1.4 V		Full range			300			150	IIA
ΔΙ _{ΙΟ} /ΔΤ	Input offset current temperature drift			Full range					10		pA/°C
l.=	Input bias current	V= -1.4.V		25°C		-20	-250		-20	-250	nA
I _{IB}	input bias current	V _O = 1.4 V		Full range			-500			-500	IIA
				25°C	0 to V _{CC} = 1.5			0 to V _{CC} = 1.5			
VICR	Common-mode input voltage range	$V_{CC} = 5 \text{ V to MA}$	X		0 to			0 to			V
				Full range	V _{CC} - 2			V _{CC} - 2			
		$R_L = 2 k\Omega$		25°C							
Vou	High-level	$R_L = 10 \text{ k}\Omega$		25°C	V _{CC} – 1.5			V _{CC} – 1.5			V
Vон	output voltage	V _{CC} = MAX	$R_L = 2 k\Omega$	Full range	22			26			V
		VCC = IVIAX	$R_L \ge 10 \text{ k}\Omega$	Full range	23	24		27			
VOL	Low-level output voltage	$R_L \le 10 \text{ k}\Omega$		Full range		5	20		5	20	mV
	Large-signal	V _{CC} = 15 V, V _O	= 1 V to 11 V	25°C	25	100		25	100		
AVD	differential voltage amplification	$R_L \ge 2 k\Omega$	- 1 1 10 11 1,	Full range	15			15			V/mV
CMRR	Common-mode rejection ratio	V _{IC} = V _{ICR} min		25°C	50	80		60	80		dB
ksvr	Supply-voltage rejection ratio (ΔV _{CC} /ΔV _{IO})			25°C	50	100		60	100		dB
V _{O1} /V _{O2}	Crosstalk attenuation	f = 1 kHz to 20 kł	Hz	25°C		120			120		dB
		V _{CC} = 15 V,		25°C	-20	-30	-60	-20	-30	-60	
		$V_{ID} = 1 V,$ $V_{O} = 0$	Source	Full range	-10			-10			
IO	Output current	V _{CC} = 15 V,		25°C	10	20		10	20		mA
		$V_{ID} = -1 \text{ V},$ $V_{O} = 15 \text{ V}$	Sink	Full range	5			5			
		V _{ID} = -1 V,	V _O = 200 mV	25°C		30		12	40		μА
IOS	Short-circuit output current	V _{CC} at 5 V, GND at –5 V	V _O = 0,	25°C		±40	±60		±40	±60	mA
		V _O = 2.5 V,	No load	Full range		0.7	1.2		0.7	1.2	
Icc	Supply current (four amplifiers)	$V_{CC} = MAX,$ $V_{O} = 0.5 V_{CC},$	No load	Full range		1.4	3		1.4	3	mA

[†] All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified. MAX V_{CC} for testing purposes is 26 V for LM2902 and 32 V for LM2902V.



[‡] Full range is -40°C to 125°C for LM2902.

[§] All typical values are at $T_A = 25$ °C.

LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V, LM224K, LM224KA, LM324K, LM324KA, LM2902KV, LM2902KAV QUADRUPLE OPERATIONAL AMPLIFIERS SLOS066R - SEPTEMBER 1975 - REVISED JANUARY 2005

electri	electrical characteristics at specified free-air temperature, V_{CC} = $5V$ (unless otherwise noted)	t specified	free-air ten	nperature	$^{\prime}$ $^{\prime}$ $^{\prime}$ $^{\prime}$	5 V (unl	ess o	therwis	e note	d)				
	PARAMETER	TEST COP	CONDITIONST	‡V1	٦	LM124A		ΓW	LM224A		LM:	LM324A, LM324KA		LIND
					MIN	TYP§	MAX	MIN	TYP§	MAX	MIN	түр§	MAX	
77.		$V_{CC} = 5 \text{ V to } 30 \text{ V,}$	٧,	25°C			2		2	3		2	3	/ 1000
OI _^	input oirset voitage	VIC = VICRmin, VO	VO = 1.4 V	Full range			4			4			2	У Ш
	1	V 4.4.V.		25°C			10		2	15		2	30	< 1
Ol	input offset current	VO = 1.4 V		Full range			30			30			75	ΝΑ
	400000000000000000000000000000000000000	77- 447		25°C			-20		-15	-80		-15	-100	< 1
B	input bias current	VO = 1.4 V		Full range			-100			-100			-200	HA
	Common-mode input	7.00		25°C	0 to VCC - 1.5			0 to VCC - 1.5			0 to VCC - 1.5			>
VICR	voltage range	\ CC = 30 \		Full range	0 to VCC - 2			0 to VCC - 2			0 to VCC - 2			>
		$R_L = 2 \text{ k}\Omega$		25°C	V _{CC} – 1.5		^	Vcc - 1.5		_	Vcc - 1.5			
ΛОН	High-level output voltage	77 - 78	$R_L = 2 \text{ k}\Omega$	Full range	56			26			26			>
		VCC = 30 V	$R_L \ge 10 \text{ k}\Omega$	Full range	27			27	28		27	28		
NOL	Low-level output voltage	$R_{L} \le 10 \text{ k}\Omega$		Full range			20		2	20		2	20	μV
	Large-signal differential	VCC = 15 V, VO	$V_{Q} = 1 \text{ V to } 11 \text{ V,}$	25°C	20	100		20	100		25	100		/ / /may /
AVD	voltage amplification	$R_L \ge 2 \ k\Omega$		Full range	25			25			15			٨/١١١٨
CMRR	Common-mode rejection ratio	VIC = VICRmin		25°C	20			70	80		92	80		dB
ksvr	Supply-voltage rejection ratio (ΔV _{CC} /ΔV _{IO})			25°C	65			92	100		99	100		ВВ
VO1/VO2	2 Crosstalk attenuation	f = 1 kHz to 20 kHz	(Hz	25°C		120			120			120		dВ
		$V_{CC} = 15 \text{ V},$	Source	25°C	-20			-20	-30	09-	-20	-30	09-	
		$^{\text{VID}} = 1 \text{ V}, \\ ^{\text{VO}} = 0$		Full range	-10			-10			-10			<
<u>o</u>	Output current	$V_{CC} = 15 \text{ V},$	<u> </u>	25°C	10			10	20		10	20		Ĭ
		$V_{1D} = -1 V,$ $V_{0} = 15 V$	SIIIK	Full range	5			5			5			
		$V_{ID} = -1 V,$	$V_{O} = 200 \text{ mV}$	25°C	12			12	30		12	30		μA
so _l	Short-circuit output current	V_{CC} at 5 V, $V_{O} = 0$	GND at -5 V,	25°C		∓40	09∓		∓40	09∓		±40	09∓	mA
	Access of Access	V _O = 2.5 V,	No load	Full range		0.7	1.2		0.7	1.2		0.7	1.2	
၁၁၂	(four amplifiers)	$V_{CC} = 30 \text{ V},$ No load	VO = 15 V,	Full range		1.4	8		4.1	в		4.1	8	mA
† All char ‡ Full ran § All typic	† All characteristics are measured under open-loop conditions, with zero common-mode input voltage \ddagger Full range is -55° C to 125° C for LM124A, -25° C to 85° C for LM224A, and 0° C to 70° C for LM324A. § All typical values are at $T_{A} = 25^{\circ}$ C.	r open-loop con !4A, –25°C to 8€	conditions, with zero common-mode input voltage, unless otherwise specified. o 85°C for LM224A, and 0°C to 70°C for LM324A.	ocommon-mo and 0°C to 70	ode input vol 0°C for LM3	tage, unles: 24A.	s other	vise specifi	- p					

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LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V, LM224K, LM224KA, LM324K, LM324KA, LM2902K, LM2902KV, LM2902KAV QUADRUPLE OPERATIONAL AMPLIFIERS

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operating conditions, V_{CC} = ± 15 V, T_A = $25^{\circ}C$

	PARAMETER	TEST CONDITIONS	TYP	UNIT
SR	Slew rate at unity gain	$R_L = 1 M\Omega$, $C_L = 30 pF$, $V_I = \pm 10 V$ (see Figure 1)	0.5	V/μs
B ₁	Unity-gain bandwidth	$R_L = 1 M\Omega$, $C_L = 20 pF$ (see Figure 1)	1.2	MHz
Vn	Equivalent input noise voltage	$R_S = 100 \Omega$, $V_I = 0 V$, $f = 1 kHz$ (see Figure 2)	35	nV/√Hz

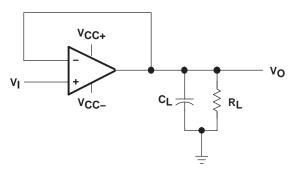


Figure 1. Unity-Gain Amplifier

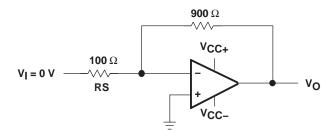


Figure 2. Noise-Test Circuit



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-7704301VCA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
77043012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
7704301CA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
7704301DA	ACTIVE	CFP	W	14	1	TBD	A42 SNPB	N / A for Pkg Type
77043022A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
7704302CA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
7704302DA	ACTIVE	CFP	W	14	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/11005BCA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM124ADR	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
LM124AFKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
LM124AJ	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM124AJB	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM124AWB	ACTIVE	CFP	W	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM124D	ACTIVE	SOIC	D	14	50	TBD	CU NIPDAU	Level-3-245C-168 HR
LM124DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM124DR	ACTIVE	SOIC	D	14	2500	TBD	CU NIPDAU	Level-3-245C-168 HR
LM124DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM124FKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
LM124J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM124JB	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM124N	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
LM124W	ACTIVE	CFP	W	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM124WB	ACTIVE	CFP	W	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM224AD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224ADE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224ADG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224ADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224ADRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224ADRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224AN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM224ANE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM224D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224DG4	ACTIVE	SOIC	D	14	50	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIM





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Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³
						no Sb/Br)		
LM224DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM224KAD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224KADE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM224KADG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM224KADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM224KADRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM224KADRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM224KAN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM224KANE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM224KD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM224KDE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM224KDG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM224KDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM224KDRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM224KDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM224KN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM224KNE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM224N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM224NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM2902D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM2902DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM2902DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM2902DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN





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Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Packag Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	n MSL Peak Temp ⁽³⁾
LM2902DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KAVQDR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAL Level-1-235C-UNLIM
LM2902KAVQDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KAVQPWR	ACTIVE	TSSOP	PW	14	2000	TBD	CU NIPDAU	Level-1-250C-UNLIM
_M2902KAVQPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDB	ACTIVE	SSOP	DB	14	80	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDBE4	ACTIVE	SSOP	DB	14	80	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDBG4	ACTIVE	SSOP	DB	14	80	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDBR	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDBRE4	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDBRG4	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM2902KNE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM2902KNSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KNSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KNSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KPW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KPWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KPWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM





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Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp (3)
LM2902KPWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KPWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KVQDR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR Level-1-235C-UNLIM
LM2902KVQDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KVQPWR	ACTIVE	TSSOP	PW	14	2000	TBD	CU NIPDAU	Level-1-250C-UNLIM
LM2902KVQPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM2902NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM2902NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902NSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902PW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902PWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902PWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902PWLE	OBSOLETE	TSSOP	PW	14		TBD	Call TI	Call TI
LM2902PWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902PWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902PWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902QN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
LM324AD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ADBLE	OBSOLETE	SSOP	DB	14		TBD	Call TI	Call TI
LM324ADBR	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ADBRE4	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ADBRG4	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ADE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ADG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ADRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIM





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Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
						no Sb/Br)		
LM324ADRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324AN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM324ANE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM324ANSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ANSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ANSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324APW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324APWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324APWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324APWLE	OBSOLETE	TSSOP	PW	14		TBD	Call TI	Call TI
LM324APWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324APWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324APWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KAD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KADE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KADG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KADRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KADRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KAN	ACTIVE	PDIP	N	14	25	Pb-Free	CU NIPDAU	N / A for Pkg Type





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Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp
						(RoHS)		
LM324KANE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM324KANS	PREVIEW	SO	NS	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM324KANSG4	PREVIEW	SO	NS	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM324KANSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM324KANSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM324KANSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM324KAPW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
LM324KAPWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLII
LM324KAPWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLII
LM324KAPWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLI
LM324KAPWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLI
LM324KAPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLI
LM324KD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLI
LM324KDE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLI
LM324KDG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLI
LM324KDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLI
LM324KDRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLI
LM324KDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLI
LM324KN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM324KNE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM324KNS	PREVIEW	SO	NS	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLI
LM324KNSG4	PREVIEW	SO	NS	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLI
LM324KNSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLI
LM324KNSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLI
LM324KNSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLI





om 18-Sep-2008

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Packag Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
LM324KPW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KPWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KPWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KPWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KPWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM324NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM324NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324NSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324NSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324PW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324PWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324PWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324PWLE	OBSOLETE	TSSOP	PW	14		TBD	Call TI	Call TI
LM324PWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324PWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324PWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324Y	OBSOLETE	DIESALE	Υ	0		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.



PACKAGE OPTION ADDENDUM

18-Sep-2008

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF LM124, LM124-SP, LM124M, LM2902:

• Automotive: LM2902-Q1

● Enhanced Product: LM2902-EP

NOTE: Qualified Version Definitions:

- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product Supports Defense, Aerospace and Medical Applications





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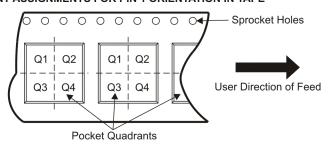
TAPE AND REEL INFORMATION



TAPE DIMENSIONS + K0 - P1 - B0 W Cavity - A0 -

	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

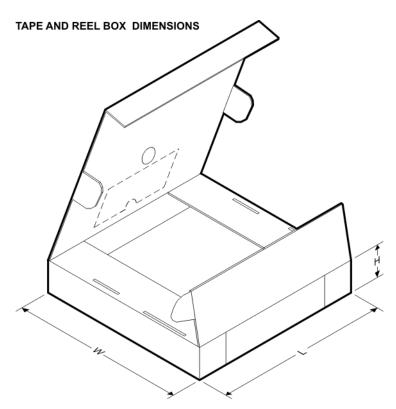
Device	Package	Package	Pins	SPQ	Reel	Reel	A0 (mm)	B0 (mm)	K0 (mm)	P1	W	Pin1
201100	Type	Drawing		1	Diameter			20 ()	()	(mm)		Quadrant
LM224ADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM224DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM224KADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM224KDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM2902DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM2902DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM2902KDBR	SSOP	DB	14	2000	330.0	16.4	8.2	6.6	2.5	12.0	16.0	Q1
LM2902KDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM2902KNSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
LM2902KPWR	TSSOP	PW	14	2000	330.0	12.4	7.0	5.6	1.6	8.0	12.0	Q1
LM2902NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
LM2902PWR	TSSOP	PW	14	2000	330.0	12.4	7.0	5.6	1.6	8.0	12.0	Q1
LM324ADBR	SSOP	DB	14	2000	330.0	16.4	8.2	6.6	2.5	12.0	16.0	Q1
LM324ADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM324ANSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
LM324APWR	TSSOP	PW	14	2000	330.0	12.4	7.0	5.6	1.6	8.0	12.0	Q1
LM324DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM324DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1





com 16-Jul-2008

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM324KADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM324KANSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
LM324KAPWR	TSSOP	PW	14	2000	330.0	12.4	7.0	5.6	1.6	8.0	12.0	Q1
LM324KDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM324KNSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
LM324KPWR	TSSOP	PW	14	2000	330.0	12.4	7.0	5.6	1.6	8.0	12.0	Q1
LM324NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
LM324PWR	TSSOP	PW	14	2000	330.0	12.4	7.0	5.6	1.6	8.0	12.0	Q1



*All dimensions are nominal

	1	_					T
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM224ADR	SOIC	D	14	2500	346.0	346.0	33.0
LM224DR	SOIC	D	14	2500	346.0	346.0	33.0
LM224KADR	SOIC	D	14	2500	346.0	346.0	33.0
LM224KDR	SOIC	D	14	2500	346.0	346.0	33.0
LM2902DR	SOIC	D	14	2500	346.0	346.0	33.0
LM2902DR	SOIC	D	14	2500	333.2	345.9	28.6
LM2902KDBR	SSOP	DB	14	2000	346.0	346.0	33.0
LM2902KDR	SOIC	D	14	2500	346.0	346.0	33.0
LM2902KNSR	SO	NS	14	2000	346.0	346.0	33.0



PACKAGE MATERIALS INFORMATION

16-Jul-2008

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM2902KPWR	TSSOP	PW	14	2000	346.0	346.0	29.0
LM2902NSR	SO	NS	14	2000	346.0	346.0	33.0
LM2902PWR	TSSOP	PW	14	2000	346.0	346.0	29.0
LM324ADBR	SSOP	DB	14	2000	346.0	346.0	33.0
LM324ADR	SOIC	D	14	2500	346.0	346.0	33.0
LM324ANSR	SO	NS	14	2000	346.0	346.0	33.0
LM324APWR	TSSOP	PW	14	2000	346.0	346.0	29.0
LM324DR	SOIC	D	14	2500	333.2	345.9	28.6
LM324DR	SOIC	D	14	2500	346.0	346.0	33.0
LM324KADR	SOIC	D	14	2500	346.0	346.0	33.0
LM324KANSR	SO	NS	14	2000	346.0	346.0	33.0
LM324KAPWR	TSSOP	PW	14	2000	346.0	346.0	29.0
LM324KDR	SOIC	D	14	2500	346.0	346.0	33.0
LM324KNSR	SO	NS	14	2000	346.0	346.0	33.0
LM324KPWR	TSSOP	PW	14	2000	346.0	346.0	29.0
LM324NSR	SO	NS	14	2000	346.0	346.0	33.0
LM324PWR	TSSOP	PW	14	2000	346.0	346.0	29.0

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK

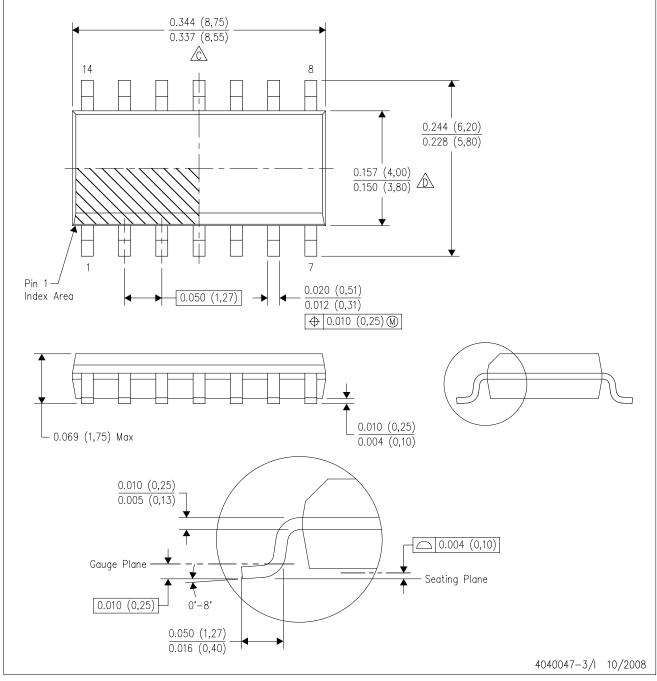


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AB.



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